

74VHC164

8-Bit Serial-In, Parallel-Out Shift Register

General Description

The VHC164 is an advanced high-speed CMOS device fabricated with silicon gate CMOS technology. It achieves the high-speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation. The VHC164 is a high-speed 8-Bit Serial-In/Parallel-Out Shift Register. Serial data is entered through a 2-input AND gate synchronous with the LOW-to-HIGH transition of the clock. The device features an asynchronous Master Reset which clears the register, setting all outputs LOW independent of the clock. An input protection circuit insures that 0V to 7V can be applied to the input pins without regard to the supply voltage. This device can be used

to interface 5V to 3V systems and two supply systems such as battery backup. This circuit prevents device destruction due to mismatched supply and input voltages.

Features

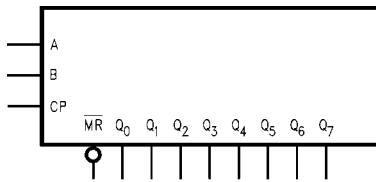
- High Speed: $f_{MAX} = 175$ MHz at $V_{CC} = 5V$
- Low power dissipation: $I_{CC} = 4 \mu A$ (max) at $T_A = 25^\circ C$
- High noise immunity: $V_{NIH} = V_{NIL} = 28\% V_{CC}$ (min)
- Power down protection provided on all inputs
- Low noise: $V_{OLP} = 0.8V$ (max)
- Pin and function compatible with 74HC164

Ordering Code:

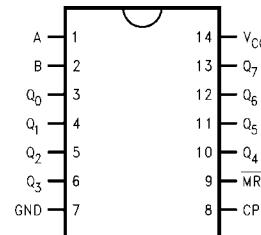
Order Number	Package Number	Package Description
74VHC164M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150 Narrow
74VHC164SJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74VHC164MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
74VHC164N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Surface mount packages are also available on Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Logic Symbol



Connection Diagram



Pin Descriptions

Pin Names	Description
A, B	Data Inputs
CP	Clock Pulse Input (Active Rising Edge)
MR	Master Reset Input (Active LOW)
Q_0-Q_7	Outputs

Functional Description

The VHC164 is an edge-triggered 8-bit shift register with serial data entry and an output from each of the eight stages. Data is entered serially through one of two inputs (A or B); either of these inputs can be used as an active High Enable for data entry through the other input. An unused input must be tied HIGH.

Each LOW-to-HIGH transition on the Clock (CP) input shifts data one place to the right and enters into Q_0 the logical AND of the two data inputs ($A \bullet B$) that existed before the rising clock edge. A LOW level on the Master Reset (MR) input overrides all other inputs and clears the register asynchronously, forcing all Q outputs LOW.

Function Table

Operating Mode	Inputs		Outputs	
	\overline{MR}	A B	Q_0	Q_1-Q_7
Reset (Clear)	L	X X	L	L-L
Shift	H	L L	L	Q_0-Q_6
	H	L H	L	Q_0-Q_6
	H	H L	L	Q_0-Q_6
	H	H H	H	Q_0-Q_6

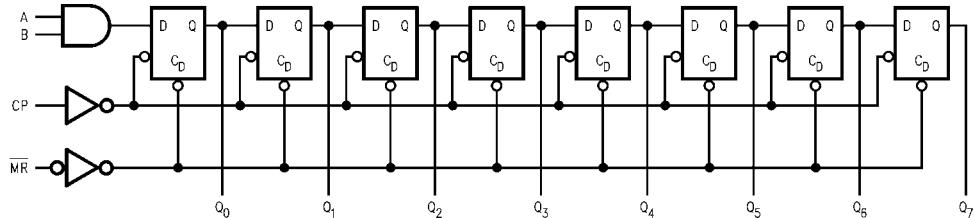
H = HIGH Voltage Levels

L = LOW Voltage Levels

X = Immaterial

Q = Lower case letters indicate the state of the referenced input or output one setup time prior to the LOW-to-HIGH clock transition.

Logic Diagram



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Absolute Maximum Ratings (Note 1)				Recommended Operating Conditions (Note 2)						
Symbol	Parameter	V _{CC} (V)	T _A = 25°C		T _A = -40°C to +85°C		Units	Conditions		
			Min	Typ	Max	Min				
			Supply Voltage (V _{CC})	-0.5V to +7.0V		Supply Voltage (V _{CC})	2.0V to 5.5V			
			DC Input Voltage (V _{IN})	-0.5V to + 7.0V		Input Voltage (V _{IN})	0V to +5.5V			
			DC Output Voltage (V _{OUT})	-0.5V to V _{CC} + 0.5V		Output Voltage (V _{OUT})	0V to V _{CC}			
			DC Diode Current (I _{DI})	-20 mA		Operating Temperature (T _{OPR})	-40°C to +85°C			
			Output Diode Current (I _{OD})	±20 mA		Input Rise and Fall Time (t _r , t _f)	0 ns/V ~ 100 ns/V			
			DC Output Current (I _{OUT})	±25 mA		V _{CC} = 3.3V ± 0.3V	0 ns/V ~ 20 ns/V			
			DC V _{CC} /GND Current (I _{CC})	±75 mA		V _{CC} = 5.0V ± 0.5V				
			Storage Temperature (T _{STG})	-65°C to +150°C						
Lead Temperature (T _L) (Soldering, 10 seconds)		260°C								
Note 1: Absolute maximum ratings are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation of circuits outside databook specifications.										
Note 2: Unused inputs must be held HIGH or LOW. They may not float.										
DC Electrical Characteristics										
Symbol	Parameter	V _{CC} (V)	T _A = 25°C		T _A = -40°C to +85°C		Units	Conditions		
			Min	Typ	Max	Min				
			V _{IH}	HIGH Level Input Voltage	2.0 3.0– 5.5	1.50 0.7 V _{CC}	1.50 0.7 V _{CC}	V		
			V _{IL}	LOW Level Input Voltage	2.0 3.0 – 5.5	0.50 0.3 V _{CC}	0.50 0.3 V _{CC}	V		
			V _{OH}	HIGH Level Output Voltage	2.0 3.0 4.5	1.9 2.9 4.4	2.0 3.0 4.5	V	V _{IN} = V _{IH} or V _{IL} I _{OH} = -50 µA	
					3.0 4.5	2.58 3.94	2.48 3.80	V	I _{OH} = -4 mA I _{OH} = -8 mA	
				LOW Level Output Voltage	2.0 3.0 4.5	0.0 0.0 0.0	0.1 0.1 0.1	V	V _{IN} = V _{IH} or V _{IL} I _{OL} = 50 µA	
					3.0 4.5	0.36 0.36	0.44 0.44	V	I _{OL} = 4 mA I _{OL} = 8 mA	
			I _{IN}	Input Leakage Current	0 – 5.5	±0.1	±1.0	µA	V _{IN} = 5.5V or GND	
			I _{CC}	Quiescent Supply Current	5.5	4.0	40.0	µA	V _{IN} = V _{CC} or GND	
Noise Characteristics										
Symbol	Parameter	V _{CC} (V)	T _A = 25°C		Units	Conditions				
			Typ	Limits						
			V _{OLP} (Note 3)	Quiet Output Maximum Dynamic V _{OL}	V	C _L = 50 pF				
			V _{OLV} (Note 3)	Quiet Output Minimum Dynamic V _{OL}	V	C _L = 50 pF				
			V _{IHD} (Note 3)	Minimum HIGH Level Dynamic Input Voltage	V	C _L = 50 pF				
			V _{ILD} (Note 3)	Maximum LOW Level Dynamic Input Voltage	V	C _L = 50 pF				
Note 3: Parameter guaranteed by design.										

AC Electrical Characteristics

Symbol	Parameter	V _{CC} (V)	T _A = 25°C			T _A = -40°C to +85°C		Units	Conditions
			Min	Typ	Max	Min	Max		
f _{MAX}	Maximum Clock Frequency	3.3 ± 0.3	80	125		65		MHz	C _L = 15 pF
			50	75		45			C _L = 50 pF
		5.0 ± 0.5	125	175		105		MHz	C _L = 15 pF
			85	115		75			C _L = 50 pF
t _{PLH} t _{PHL}	Propagation Delay Time (CP–Q _n)	3.3 ± 0.3		8.4	12.8	1.0	15.0	ns	C _L = 15 pF
				10.9	16.3	1.0	18.5		C _L = 50 pF
		5.0 ± 0.5		5.8	9.0	1.0	10.5	ns	C _L = 15 pF
				7.3	11.0	1.0	12.5		C _L = 50 pF
t _{PLH} t _{PHL}	Propagation Delay Time (MR–Q _n)	3.3 ± 0.3		8.3	12.8	1.0	15.0	ns	C _L = 15 pF
				10.8	16.3	1.0	18.5		C _L = 50 pF
		5.0 ± 0.5		5.2	8.6	1.0	10.0	ns	C _L = 15 pF
				6.7	10.6	1.0	12.0		C _L = 50 pF
C _{IN}	Input Capacitance			4	10		10	pF	V _{CC} = Open
C _{PD}	Power Dissipation Capacitance			76				pF	(Note 4)

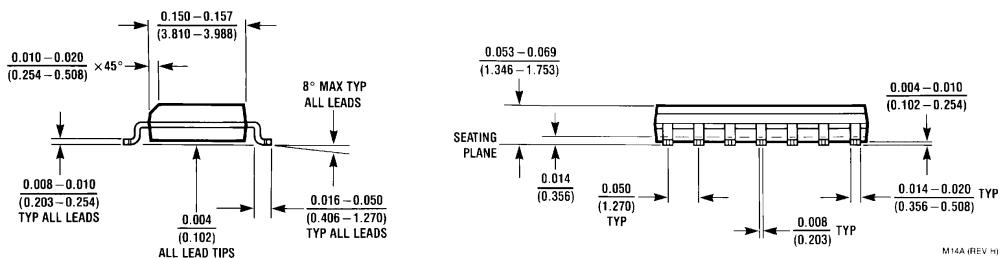
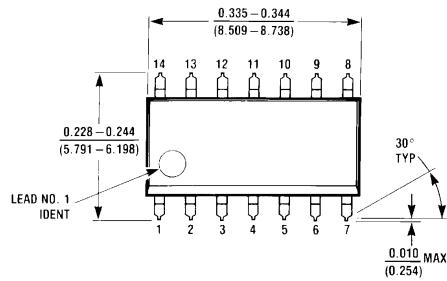
Note 4: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained from the equation: I_{CC} (opr.) = C_{PD} * V_{CC} * f_{IN} + I_{CC}.

AC Operating Requirements

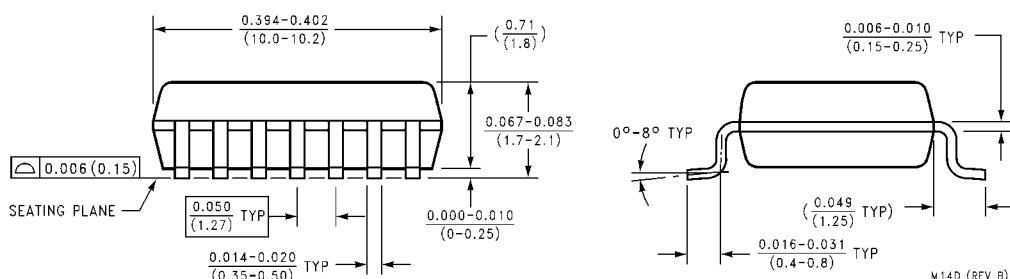
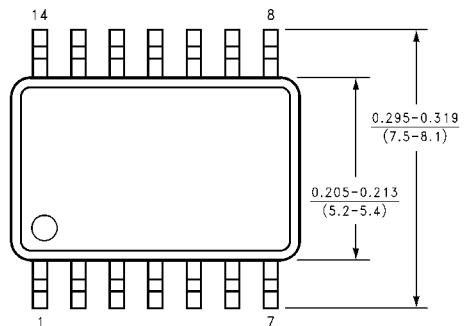
Symbol	Parameter	V _{CC} (V) (Note 5)	T _A = 25°C		T _A = -40°C to +85°C		Units
			Typ	Guaranteed Minimum			
t _{W(L)} t _{W(H)}	Minimum Pulse Width (CP)	3.3		5.0	5.0		ns
		5.0		5.0	5.0		
t _{W(L)}	Minimum Pulse Width (MR)	3.3		5.0	5.0		ns
		5.0		5.0	5.0		
t _S	Minimum Setup Time	3.3		5.0	6.0		ns
		5.0		4.5	4.5		
t _H	Minimum Hold Time	3.3		0.0	0.0		ns
		5.0		1.0	1.0		
t _{REC}	Minimum Removal Time (MR)	3.3		2.5	2.5		ns
		5.0		2.5	2.5		

Note 5: V_{CC} is 3.3 ± 0.3V or 5.0 ± 0.5V

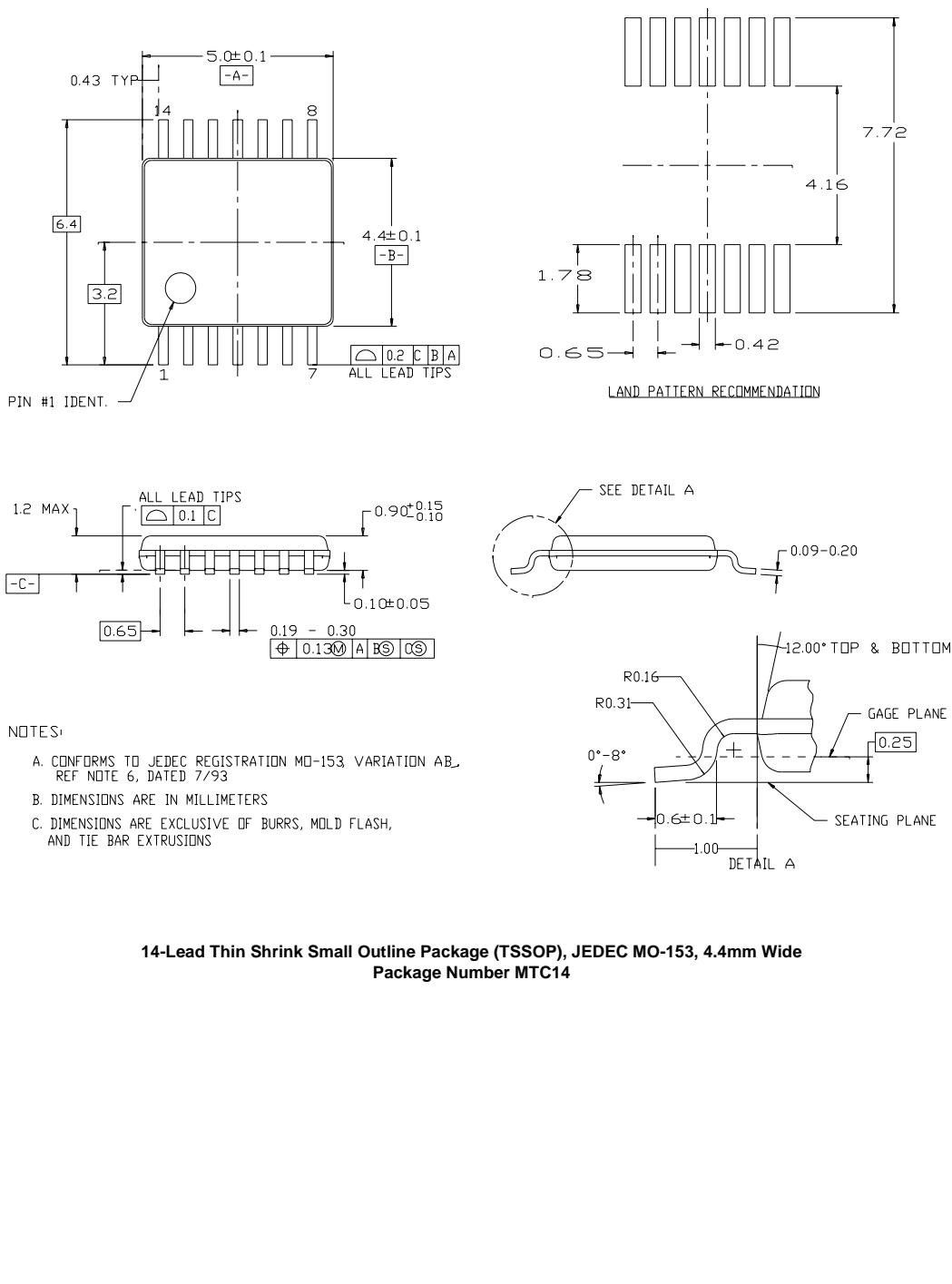
Physical Dimensions inches (millimeters) unless otherwise noted



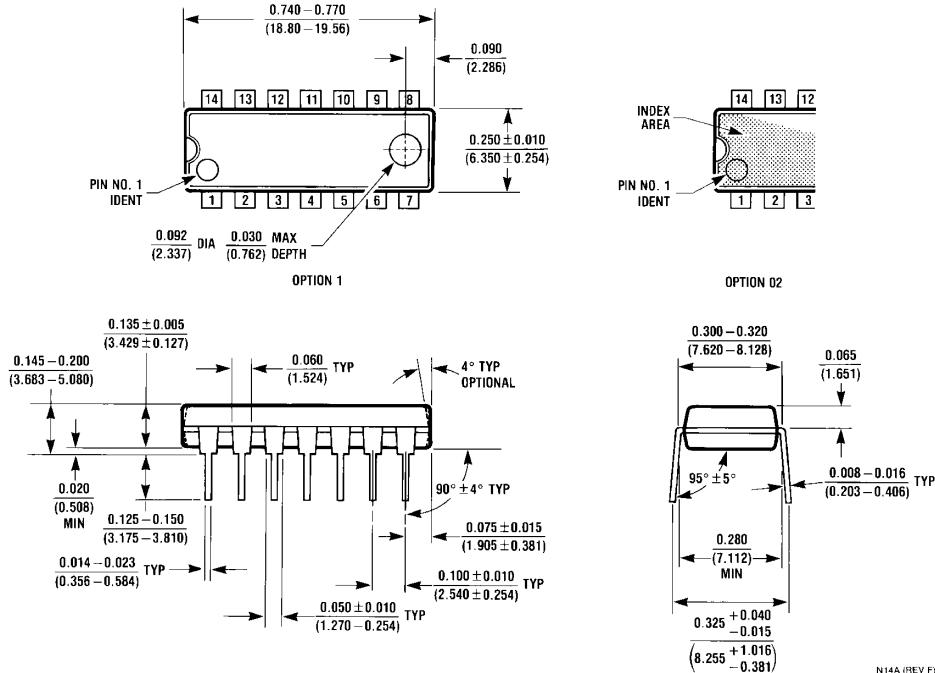
14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150 Narrow Package Number M14A



14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide Package Number M14D

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide
Package Number N14A

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

www.fairchildsemi.com